TE Internal #: 487923-1

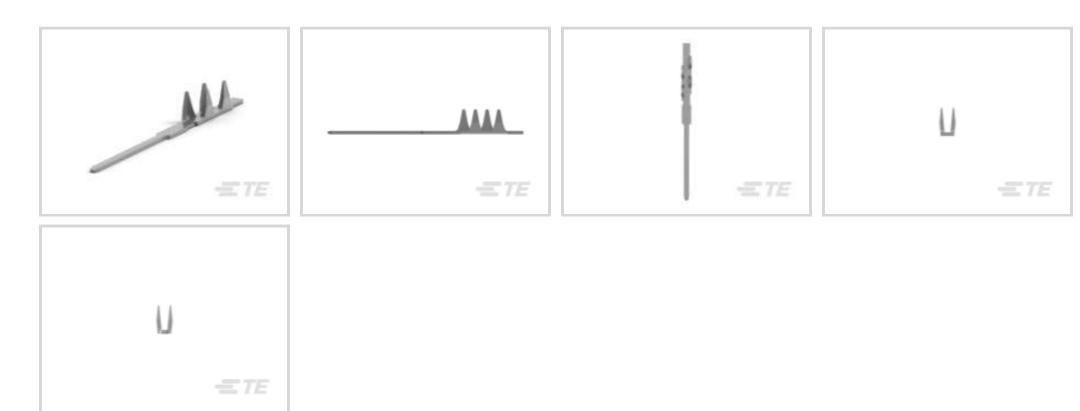
FFC Contacts, .05 in [1.27 mm] Centerline, FFC, Pin, Tin-Lead, Reel,

Solder Tab, 1.5 A, -67 – 221 °F [-55 – 105 °C]

View on TE.com >



Connectors > PCB Connectors > Wire-to-Board Connectors > FFC, FPC & Ribbon Connectors > FFC Contacts > FFC Connector Pin Contacts, 1.27 mm



Centerline (Pitch): 1.27 mm [ .05 in ]

Compatible With Wire & Cable Type: FFC

Contact Type: Pin

Contact Mating Area Plating Material: Tin-Lead

Packaging Method: Reel

All FFC Connector Pin Contacts, 1.27 mm (8)

## **Features**

## **Product Type Features**

Connector & Contact Terminates To	Wire & Cable
Configuration Features	
Compatible With Wire & Cable Type	FFC
Contact Features	
Contact Mating Area Plating Material Thickness	2.54 μm
Contact Mating Area Plating Material Finish	Bright
Contact Underplating Material	Nickel
PCB Contact Termination Area Plating Material	Tin-Lead
Contact Base Material	Phosphor Bronze
Contact Type	Pin
Contact Mating Area Plating Material	Tin-Lead
Contact Current Rating (Max)	1.5 A

#### **Termination Features**



Termination Method to Wire & Cable	Solder Tab
Housing Features	
Centerline (Pitch)	1.27 mm[.05 in]
Dimensions	
Accepts Conductor Width	.66 mm
Usage Conditions	
Operating Temperature Range	-55 – 105 °C[-67 – 221 °F]
Operation/Application	
Circuit Application	Signal
Packaging Features	
Packaging Method	Reel

## **Product Compliance**

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Not Compliant
EU ELV Directive 2000/53/EC	Compliant with Exemptions
China RoHS 2 Directive MIIT Order No 32, 2016	Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) SVHC > Threshold: Pb (13% in Component Part) Article Safe Usage Statements: Do not eat, drink or smoke when using this product. Wash thoroughly after handling. Recycle if possible and dispose of the article by following all applicable governmental regulations relevant to your geographic location.
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Reflow solder capable to 260°C

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides



on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

## Compatible Parts





# Customers Also Bought

















### **Documents**

**Product Drawings** 

FFC SDR TAB 100 FULL SN-PB

English

#### **CAD Files**

Customer View Model

ENG\_CVM\_CVM\_487923-1\_S.2d\_dxf.zip

English

3D PDF

3D

Customer View Model ENG\_CVM\_CVM\_487923-1\_S.3d\_igs.zip

08/08/2023 07:55PM | Page 3



English

**Customer View Model** 

ENG\_CVM\_CVM\_487923-1\_S.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

**Product Specifications** 

**Application Specification** 

English